

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t3083mpfe#pbf

(Engineering Calculation)

TSSOP Exp. Pad

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TOTAL MASS (g) : 0.067427

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003418	1000000	50691.9257812		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.025576	975000	379314.40625		
		Iron (Fe)	7439-89-6	0.000630	24000	9343.45117188		
		Phosphorus (P)	7723-14-0	0.000008	300	118.646987915		
		Zinc (Zn)	7440-66-6	0.000018	700	266.955718994		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.026232	1000000	389043.46875		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.002364	1000000	35058.84375		
		External Plating Total:				0.002364	1000000	35058.84375
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.001030	1000000	15275.8007812		
Internal Plating Total:				0.001030	1000000	15275.8007812		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001009	750000	14964.3515625		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000336	250000	4983.17333984		
Die Attach Total:				0.001345	1000000	19947.5253906		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.004875	150000	72300.5078125		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.026650	820000	395242.78125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000813	25000	12057.5		
		Carbon Black (C)	1333-86-4	0.000163	5000	2417.43237305		
		Encapsulation Total:				0.032501	1000000	482018.21875
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000537	1000000	7964.17871094		
					TOTAL MASS (g) :	0.067427		